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PLEASE STAMP TO ACKNOWLEDGE RECEIPT OF THE FOLLOWING:

In Re Application of: Tokuhiwa OHIWA et al.

Serial No.: 09/604,724

Group Art Unit: 2823

Filed: June 28, 2000

Examiner: K. Eaton

For: METHOD OF MANUFACTURING SEMICONDUCTOR DEVICE

1. Response to Restriction Requirement
2. Submission of Declaration/Power of Attorney
3. Executed Declaration/Power of Attorney
4. Check \$130.00
5. Recordation Form Cover Sheet
6. Assignment to Kabushiki Kaisha Toshiba
7. Check \$40.00 (recordation fee)
8. Claim for Priority
9. Certified copy of Japanese Patent Application No. 11-183908, filed June 29, 1999



Dated May 8, 2001

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DK 10P
5-9-01

Docket No.: 4329.2335

(Due Date: 05/09/01)

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